



## Material Content Data Sheet



Sales Product Name	SAK-TC1798F-512F300EP AB			Issued		28. October 2019		
MA#	MA002285168							
Package	PG-LFBGA-516-8			Weight*		1986.11 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	31.392	1.58	1.58	15806	15806
wire	noble metal	palladium	7440-05-3	0.023	0.00		12	
	non noble metal	copper	7440-50-8	2.326	0.12	0.12	1171	1183
encapsulation	organic material	carbon black	1333-86-4	1.689	0.08		850	
	plastics	epoxy resin	-	116.548	5.87		58682	
	inorganic material	silicondioxide	60676-86-0	726.316	36.57	42.52	365698	425230
substrate	inorganic material	bariumsulfate	7727-43-7	23.317	1.17		11740	
	non noble metal	metal hydroxide	-	26.895	1.35		13542	
	plastics	acrylic resin	-	26.985	1.36		13587	
	inorganic material	amorphous silica	7631-86-9	53.790	2.71		27083	
	plastics	epoxy resin	-	95.881	4.83		48276	
	inorganic material	glass fibre wool	65997-17-3	107.581	5.42		54166	
	non noble metal	copper	7440-50-8	517.918	26.08	42.92	260769	429163
plating	noble metal	gold	7440-57-5	0.489	0.02		246	
	non noble metal	nickel	7440-02-0	1.337	0.07	0.09	673	919
solderball	noble metal	silver	7440-22-4	8.700	0.44		4380	
	non noble metal	tin	7440-31-5	239.863	12.08	12.52	120770	125150
glue	plastics	epoxy resin	-	1.266	0.06		637	
	noble metal	silver	7440-22-4	3.797	0.19	0.25	1912	2549
*deviation	< 10%	Sum in total:			100.00			1000000

### Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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